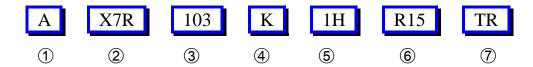
Dipped Axial Lead Type

Part Number Description



① Type

Symbol	Type
Α	Axial

2 Temperature Characteristic

Temp. Charact.	Temperature Range	Capacitance Change
NPO	-55 ~ 125°C	0±30 ppm/°C
X5R	-55 ∼ 85°C	±15%
X7R	-55 ∼ 125°C	±15%
Y5V	-30 ~ 85°C	+22%, -82%

3 Capacitance Value

Symbol	Cap. Value	
060	6pF	
6R8	6.8pF	
120	12pF	
471	470pF	
222	2200pF	
104	100000pF	

Capacitance Tolerance

Symbol	Cap.	Tol.
D	±0.5	pF
G	±2%	
J	±5%	
K	±10%	
М	±20%	
Z	+80%, -20%	

⑤ Rated Voltage

Symbol	Rated Voltage
OJ	DC 6.3V
1A	DC 10V
1C	DC 16V
1E	DC 25V
1H	DC 50V
2A	DC 100V
2E	DC 250V
2H	DC 500V

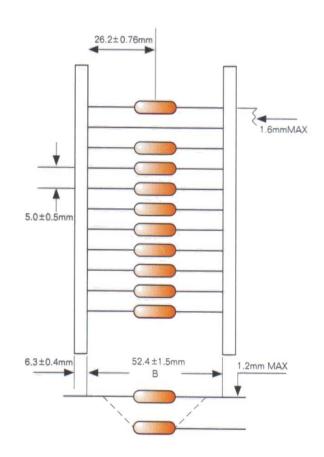
Dipped Axial Lead Type

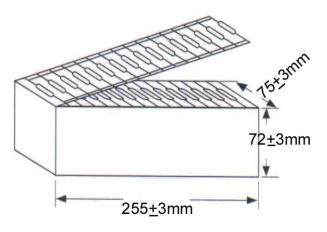
6 Size

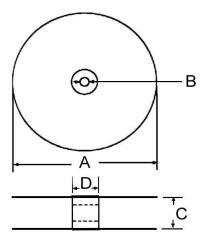
Symbol	Dimension		ı (ı	unit:mm)
Symbol	T (max)	D (max)	F (±0.8)	Фd
R15	2.8	4.2	5 7.52 10	0.5 ±0.05

⑦ Packing or Pitch of Bulk

Symbol	Packing
Blank	Bulk
Α	AMMO
R	REEL
D	5±0.8
F	7.52±0.8
G	10±0.8







Reel Pack	age			Unit:mm
Α	В	С	ם	
365max	28±1.5	51.0max	102max	

Dipped Axial Lead Type

• Capacitance Range

Style	Rate Voltage	NPO	X7R	X5R	Y5V
	6.3V			155 ~ 106	475 ~ 106
	10V			334 ~ 475	225 ~ 106
	16V		224 ~ 225	105	105 ~ 475
R15	25V		104 ~ 155	224	474 ~ 225
	50V	010 ~ 103	221 ~ 334		104 ~ 105
	100V	010 ~ 472	221 ~ 104		
	250V	101 ~ 272	102 ~ 333		

Dipped Axial Lead Type

• Electrical Characteristics

NP0

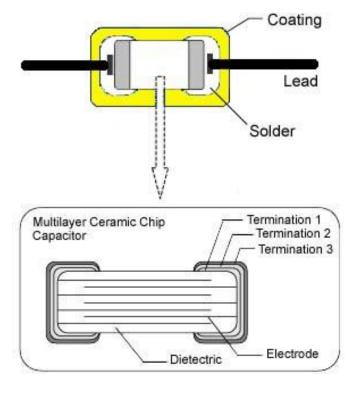
Item	Temperature Compensating	Measuring Condition
Operating Temperature Range	- 55 ~ +125°C	
Temperature Characteristics	$0\pm30~\mathrm{ppm/^\circ C}$	
Capacitance	Within the specified tolerance	Shall be measured at $25^{\circ}\text{C} \pm 2^{\circ}\text{C}$ at the frequency and voltage
Q	C \geq 30pF: Q \geq 1000 C $<$ 30pF: Q \geq 400 + 20 × C (C is nominal capacitance)	$C \le 1000 pF@1MHz \pm 20\%$, $1 \pm 0.2 Vrms$ $C > 1000 pF@1KHz \pm 10\%$, $1 \pm 0.2 Vrms$
Withstanding Voltage	No defects	Applied voltage: Rated voltage ×2.5 100V~500V Rated voltage(over) ×1.5 Duration: 1 to 5 sec. The charge/discharge current is less than 50mA
Insulation Resistance	More than $10G\Omega$ or $500M\Omega \cdot \mu$ F , whichever is less $16Vdc \ product :$ More than $10G\Omega$ or $100M\Omega \cdot \mu$ F , whichever is less	at $25^{\circ}\text{C} \pm 2^{\circ}\text{C}$ and 70% R.H. max.

• Electrical Characteristics

X7R/X5R/Y5V

Item	High Dielectric Constant		Measuring Condition
Operating Temperature Range	$X7R = -55 \sim +125^{\circ}C$ $X5R = -55 \sim +85^{\circ}C$ $Y5V = -30 \sim +85^{\circ}C$		
Temperature Characteristics		5R= ± 15% +22 to - 82%	
Capacitance	W	ithin the specified tolerance	
	25V min	X7R=0.03max. X7R=0.055max. (C≧1.0uF) Y5V=0.075max.	Shall be measured at $25^{\circ}\text{C} \pm 2^{\circ}\text{C}$ at the frequency and voltage
Dissipation Factor (tanδ)	16V	X7R/X5R=0.05max. Y5V=0.10max.	X7R/X5R/Y5V
(tano)	10V max.	X7R/X5R=0.05max. Y5V=0.125max.	$@1$ KHz $\pm 10\%$, 1 ± 0.2 Vrms
	6.3V	X5R=0.075max.	
Withstanding Voltage	No defects		Applied voltage: Rated voltage ×2.5 100V ~500V Rated voltage(over) ×1.5 Duration: 1 to 5 sec. The charge/discharge current is less than 50mA
Insulation Resistance	More than $10G\Omega$ or $500M\Omega \cdot \mu F$, whichever is less. $16Vdc \ product :$ More than $10G\Omega$ or $100M\Omega \cdot \mu F$, whichever is less.		Apply rated voltage for 1 minute at 25°C±2°C and 70% R.H. max. . 16Vdc product: Measurement voltage is 25Vdc

Material List



• Storage

1. The storage conditions should be:

Temperature = Lower than 40° C

Humidity = Lower than 70% R.H.

2. After opening the package, please store in desiccators.

Environmental and Test Characteristics

Item	Temperature Compensating	Measuring Condition
Strength of termination	Termination not to be broken or loosened Force : 5 LB min. Keep time : 10 ± 1 sec.	₹ F →
Solderability of leads	Lead wire to be soldered vertically up to the coating end point. At least 75% of lead surface is covered	Solder temperature : $235 \pm 5^{\circ}$ C Dipping : 2 ± 0.5 sec. (Flux shall be used)

Dipped Axial Lead Type

Environmental and Test Characteristics

NP0

Item	Temperature Compensating	Measuring Condition			
Resistance to Soldering heat					
ΔC	$\pm 2.5\%$ or ± 0.25 pF (Whichever is greater)				
Q	$C \ge 30 pF : Q \ge 1000$ $C < 30 pF : Q \ge 400 + 20 \times C$ (C is nominal capacitance)	The lead wire is immersed in the melted solder 1.5mm to 2mm from the main body at			
I.R.	More than $10G\Omega$ or $500M\Omega \cdot \mu F$, whichever is less. $16Vdc$ product: More than $10G\Omega$ or $100M\Omega \cdot \mu F$, whichever is less.	Let sit at room temperature for 24 ± 2 hrs.			
Withstanding voltage	No defects	Perform the initial measurement.			
Exterior	No abnormalities				
Thermal shock					
ΔC	$\pm 2.5\%$ or ± 0.25 pF (Whichever is greater)	Fix the capacitor to the supporting jig in the			
Q	$C \ge 30 pF : Q \ge 1000$ $C < 30 pF : Q \ge 400 + 20 \times C$ (C is nominal capacitance)	same manner and under the same conditions as (<i>Resistance to Soldering heat</i>). Perform the five cycles according to the four heat treatments listed in the following table.			
I.R.	More than $10G\Omega$ or $500M\Omega \cdot \mu F$, whichever is less. $16Vdc$ product: More than $10G\Omega$ or $100M\Omega \cdot \mu F$,	Remove and let sit at room temperature for 24 ± 2 hrs., then measure.			
	whichever is less.	Temp. Operating Temp. Room Operating Temp. Room Temp.			
Withstanding voltage	No defects	Time 30±3 15 30±3 15			
Exterior	No abnormalities	Perform the initial measurement.			

Environmental and Test Characteristics

NP0

Item	Temperature Compensating	Measuring Condition			
Moisture resistance	Moisture resistance (Steady state)				
ΔC	± 5% or ± 0.5pF (Whichever is greater)				
Q	C≥30pF: Q≥350 10 pF>C<30pF: Q≥275 + $\frac{5}{2}$ × C C≤10pF: Q≥200 + 10 × C (C is nominal capacitance)	Apply the rated DC voltage at $40 \pm 2^{\circ}$ C and 90 to 95% R.H. for 500^{+24}_{-0} hrs.			
I.R.	More than $1000M\Omega$ or $50M\Omega \cdot \mu$ F, whichever is less. $16Vdc$ product: More than $1000M\Omega$ or $10M\Omega \cdot \mu$ F, whichever is less.	Remove and let sit at room temperature for 24 ± 2 hrs., then measure. Perform the initial measurement.			
Withstanding voltage	No defects				
Exterior	No abnormalities				
High temperature loading					
ΔC	± 3% or ± 0.3pF (Whichever is greater)				
Q	C≥30pF: Q≥350 10 pF>C<30pF: Q≥275 + $\frac{5}{2}$ × C C≤10pF: Q≥200 + 10 × C (C is nominal capacitance)	Apply 200% of the rated DC voltage for 1000^{+48}_{-0} hrs. at the maximum operating temperature $\pm 2^{\circ}$ C. Remove and let sit at room temperature for 24 ± 2 hrs., then			
I.R.	whichever is less. 16Vdc product:	measure. The charge/discharge current is less than 50mA. Perform initial measurement. * 100% for 100V~500V over.			
Withstanding voltage	No defects				
Exterior	No abnormalities				

Environmental and Test Characteristics

X7R/X5R/Y5V

Item	Temperature Compensating	Measuring Condition		
Resistance to Soldering heat				
ΔC	$X7R/X5R = \pm 7.5\%$ $Y5V = \pm 20\%$			
D.F.	25V min X7R=0.03max. X7R=0.055max. (C≥1.0uF) Y5V=0.075max 16V X7R/X5R=0.05max. Y5V=0.10max. 10V X7R/X5R=0.05max. max. Y5V=0.125max. 6.3V X5R=0.075max.	The lead wire is immersed in the melted solder 1.5mm to 2mm from the main body at $260 \pm 5^{\circ}$ C for 10 ± 0.5 sec. Let sit at room temperature for 48 ± 4 hrs., then measure. • Initial measurement for Perform a heat treatment at 150^{+0} °C for 1 hours.		
I.R.	More than $10G\Omega$ or $500M\Omega \cdot \mu$ F, whichever is less. $16Vdc$ product : More than $10G\Omega$ or $100M\Omega \cdot \mu$ F, whichever is less.	Remove and let sit for 48 ± 4 hours at room temperature.		
Withstanding voltage	No defects			
Exterior	No abnormalities			
Thermal shock				
ΔC	$X7R/X5R = \pm 7.5\%$ $Y5V = \pm 20\%$	Fix the capacitor to the supporting jig in		
D.F.	25V min X7R=0.03max. X7R=0.055max. (C≧1.0uF) Y5V=0.075max 16V X7R/X5R=0.05max. Y5V=0.10max. 10V X7R/X5R=0.05max. max. Y5V=0.125max. 6.3V X5R=0.075max.	the same manner and under the same conditions as ($Resistance\ to\ Soldering\ heat\ $). Perform the five cycles according to the four heat treatments listed in the following table. Remove and let sit at room temperature for 48 ± 4 hrs. , then measure.		
I.R.	More than $10G\Omega$ or $500M\Omega \cdot \mu$ F , whichever is less. $16Vdc$ product : More than $10G\Omega$ or $100M\Omega \cdot \mu$ F , whichever is less.	(C) Temp. Temp. Temp. Time 30±3 15 30±3 15		
Withstanding voltage		Remove and let sit for 48 ± 4 hrs. At room temperature. Perform the initial measurement.		
Exterior	No abnormalities.	I		

Environmental and Test Characteristics

X7R/X5R/Y5V

Item	Temperature Compensating	Measuring Condition
Moisture resist	ance (Steady state)	
ΔC	$X7R/X5R = \pm 12.5\%$ $Y5V = \pm 30\%$	
D.F.	25V min	Apply the rated DC voltage at $40 \pm 2^{\circ}$ C and 90 to 95% R.H. for 500^{+24}_{-0} hrs. Remove and let sit at room temperature for 48 ± 4 hrs., then measure. • Initial measurement for Perform a heat treatment at 150^{+0}_{-10} °C for 1 hour.
I.R.	More than $1000\text{M}\Omega$ or $50\text{M}\Omega$ • μ F , which less. 16Vdc product : More than $1000\text{M}\Omega$ or $10\text{M}\Omega$ • μ F , which less.	Remove and let sit for 48 ± 4 hrs. At room temperature.
Withstanding voltage	No defects	
Exterior	No abnormalities	
High temperatur	e loading	
ΔC	$X7R/X5R = \pm 15\%$ $Y5V = \pm 30\%$	Apply 200% of the rated DC voltage for
D.F.	25V min X7R=0.06max. X7R=0.11max. (C≥1.0uF) Y5V=0.1125max 16V X7R/X5R=0.10max. Y5V=0.15max. 10V X7R/X5R=0.10max. max. Y5V=0.1875max.	1000^{+48}_{-0} hrs. at the maximum operating temperature \pm 2°C. Remove and let sit at room temperature for 48 \pm 4 hrs. , then measure. The charge/discharge current is less than 50mA. • Initial measurement for Apply 200% of
I.R.	6.3V : X5R=0.15max. More than $1000M\Omega$ or $50M\Omega$ • μ F , which less. $16Vdc$ product : More than $1000M\Omega$ or $10M\Omega$ • μ F , which less.	the rated DC voltage for 1 hour at the maximum operating temperature \pm 2°C. Remove and let sit at room temperature never is for 48 ± 4 hrs.
Withstanding voltage	No defects	Perform initial measurement. * 100% for 100V ~ 500V
Exterior	No abnormalities	